# **VS-ST330C Series**

**Vishay Semiconductors** 



### Phase Control Thyristors (Hockey PUK Version), 720 A



TO-200AB (E-PUK)

PRODUCT SUMMARY					
Package	TO-200AB (E-PUK)				
Diode variation	Single SCR				
I <sub>T(AV)</sub>	720 A				
V <sub>DRM</sub> /V <sub>RRM</sub>	400 V, 800 V, 1200 V, 1400 V, 1600 V				
V <sub>TM</sub>	1.96 V				
I <sub>GT</sub>	100 mA				
TJ	-40 °C to 125 °C				

### FEATURES

- Center amplifying gate
- Metal case with ceramic insulator
- International standard case TO-200AB (E-PUK)
- Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **TYPICAL APPLICATIONS**

- DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS								
PARAMETER	TEST CONDITIONS	VALUES	UNITS					
1		720	A					
I <sub>T(AV)</sub>	T <sub>hs</sub>	55	°C					
1		1420	A					
I <sub>T(RMS)</sub>	T <sub>hs</sub>	25	°C					
1	50 Hz	9000	•					
ITSM	60 Hz	9420	A					
l <sup>2</sup> t	50 Hz	405	kA <sup>2</sup> s					
1-1	60 Hz	370	KA-S					
V <sub>DRM</sub> /V <sub>RRM</sub>		400 to 1600	V					
tq	Typical	100	μs					
TJ		-40 to 125	°C					

### **ELECTRICAL SPECIFICATIONS**

VOLTAGE RATINGS									
TYPE NUMBER	VOLTAGE CODE	V <sub>DRM</sub> /V <sub>RRM</sub> , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V <sub>RSM</sub> , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	I <sub>DRM</sub> /I <sub>RRM</sub> MAXIMUM AT T <sub>J</sub> = T <sub>J</sub> MAXIMUM mA					
	04	400	500						
	08	800	900						
VS-ST330CC	12	1200	1300	50					
	14	1400	1500						
	16	1600	1700						

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COMPLIANT

## **VS-ST330C Series**



Vishay Semiconductors

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL		TEST CON	DITIONS	VALUES	UNITS	
Maximum average on-state current	1	180° condu	ction, half sine v	720 (350)	А		
at heatsink temperature	I <sub>T(AV)</sub>	double side	(single side) co	oled	55 (75)	°C	
Maximum RMS on-state current	I <sub>T(RMS)</sub>	DC at 25 °C	heatsink tempe	erature double side cooled	1420		
		t = 10 ms	No voltage		9000		
Maximum peak, one-cycle	I	t = 8.3 ms	reapplied		9420	А	
non-repetitive surge current	I <sub>TSM</sub>	t = 10 ms	100 % V <sub>RRM</sub>		7570		
		t = 8.3 ms	reapplied	Sinusoidal half wave,	7920		
	t = 10  ms $t = 8.3  ms$	No voltage	initial $T_J = T_J$ maximum	405			
Man .:		t = 8.3 ms	reapplied		370	kA <sup>2</sup> s	
Maximum I <sup>2</sup> t for fusing	1-1	t = 10 ms	100 % V <sub>RRM</sub>		287		
		t = 8.3 ms	reapplied		262		
Maximum I <sup>2</sup> $\sqrt{t}$ for fusing	l²√t	t = 0.1 to 10	) ms, no voltage	reapplied	4050	kA²√s	
Low level value of threshold voltage	V <sub>T(TO)1</sub>	(16.7 % x π	$x  _{T(AV)} < l < \pi x$	$I_{T(AV)}$ ), $T_J = T_J$ maximum	0.91	v	
High level value of threshold voltage	V <sub>T(TO)2</sub>	$(I > \pi \times I_{T(AV)})$	), $T_J = T_J$ maxin	num	0.92	v	
Low level value of on-state slope resistance	r <sub>t1</sub>	(16.7 % x π	(16.7 % x $\pi$ x $I_{T(AV)}$ < I < $\pi$ x $I_{T(AV)}$ ), T <sub>J</sub> = T <sub>J</sub> maximum			mΩ	
High level value of on-state slope resistance	r <sub>t2</sub>	$(I > \pi x I_{T(AV)}), T_J = T_J maximum$			0.57	11152	
Maximum on-state voltage	V <sub>TM</sub>	I <sub>pk</sub> = 1810 A	$I_{pk} = 1810 \text{ A}, T_J = T_J \text{ maximum, } t_p = 10 \text{ ms sine pulse}$			V	
Maximum holding current	Ι <sub>Η</sub>	T _ 05 °C	anada aunahi 1	2. V registive load	600	m 4	
Typical latching current	١L	$1_{\rm J} = 25$ C,	anoue supply 1	2 V resistive load	1000	mA	

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum non-repetitive rate of rise of turned-on current	dl/dt	Gate drive 20 V, 20 $\Omega,t_r \leq 1~\mu s$ $T_J$ = $T_J$ maximum, anode voltage $\leq 80~\%~V_{DRM}$	1000	A/µs
Typical delay time	t <sub>d</sub>	Gate current 1 A, dl <sub>g</sub> /dt = 1 A/ $\mu$ s V <sub>d</sub> = 0.67 % V <sub>DRM</sub> , T <sub>J</sub> = 25 °C	1.0	
Typical turn-off time	tq	$I_{TM}$ = 550 A, $T_J$ = $T_J$ maximum, dl/dt = 40 A/µs, $V_R$ = 50 V, dV/dt = 20 V/µs, gate 0 V 100 $\Omega,$ $t_p$ = 500 µs	100	μs

BLOCKING								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum critical rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum linear to 80 % rated $V_{DRM}$	500	V/µs				
Maximum peak reverse and off-state leakage current	I <sub>RRM</sub> , I <sub>DRM</sub>	$T_J = T_J$ maximum, rated $V_{DRM}/V_{RRM}$ applied	50	mA				





TRIGGERING							
PARAMETER	SYMBOL	TE	VAL	UNITS			
FARAMETER	STWBOL		TEST CONDITIONS				
Maximum peak gate power	P <sub>GM</sub>	$T_J = T_J$ maximum,	t <sub>p</sub> ≤ 5 ms	10	0.0	w	
Maximum average gate power	P <sub>G(AV)</sub>	$T_J = T_J$ maximum,	f = 50 Hz, d% = 50	2	.0	vv	
Maximum peak positive gate current	I <sub>GM</sub>	$T_J = T_J$ maximum,	t <sub>p</sub> ≤ 5 ms	3	.0	А	
Maximum peak positive gate voltage	+ V <sub>GM</sub>					v	
Maximum peak negative gate voltage	- V <sub>GM</sub>	$T_J = T_J$ maximum,	5.0		v		
		T <sub>J</sub> = -40 °C		200	-		
DC gate current required to trigger	I <sub>GT</sub>	T <sub>J</sub> = 25 °C	Maximum required gate trigger/	100	200	mA	
		T <sub>J</sub> = 125 °C	current/voltage are the lowest	50	-		
		T <sub>J</sub> = -40 °C	value which will trigger all units	2.5	-		
DC gate voltage required to trigger	V <sub>GT</sub>	T <sub>J</sub> = 25 °C	12 V anode to cathode applied	1.8	3.0	V	
		T <sub>J</sub> = 125 °C		1.1	-		
DC gate current not to trigger	I <sub>GD</sub>	T. T	Maximum gate current/voltage not to trigger is the maximum	10		mA	
DC gate voltage not to trigger	V <sub>GD</sub>	$T_J = T_J maximum$	value which will not trigger any unit with rated V <sub>DRM</sub> anode to cathode applied	0.25		v	

THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum operating junction temperature range	TJ		-40 to 125	°C			
Maximum storage temperature range	T <sub>Stg</sub>		-40 to 150	U			
Maximum thermal resistance, junction to heatsink	D	DC operation single side cooled	0.09				
Maximum mermanesistance, junction to heatsink	R <sub>thJ-hs</sub>	DC operation double side cooled	0.04	K/W			
Maximum thermal resistance, case to heatsink	R <sub>thC-hs</sub>	DC operation single side cooled	0.02	r√ vv			
		DC operation double side cooled	0.01				
Mounting force, ± 10 %			9800 (1000)	N (kg)			
Approximate weight			83	g			
Case style		See dimensions - link at the end of datasheet	TO-200AB (E	E-PUK)			

CONDUCTION ANGLE			RECTANGULAR	R CONDUCTION	TEST CONDITIONS	UNITS			
CONDUCTION ANGLE	SINGLE SIDE	DOUBLE SIDE	SINGLE SIDE	DOUBLE SIDE	TEST CONDITIONS	UNITS			
180°	0.012	0.011	0.008	0.007					
120°	0.014	0.012	0.014	0.013		K/W			
90°	0.017	0.015	0.019	0.017	$T_J = T_J maximum$				
60°	0.025	0.022	0.026	0.023					
30°	0.043	0.036	0.043	0.037					

Note

The table above shows the increment of thermal resistance RthJ-hs when devices operate at different conduction angles than DC

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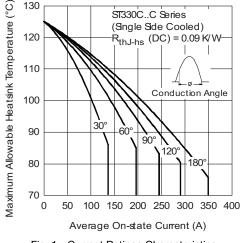


Fig. 1 - Current Ratings Characteristics

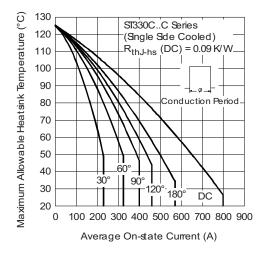
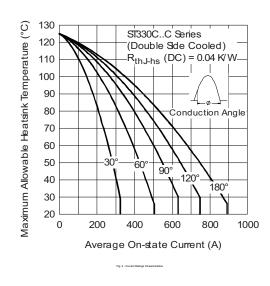
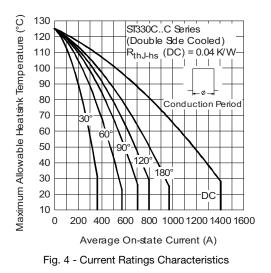


Fig. 2 - Current Ratings Characteristics





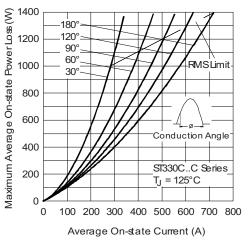


Fig. 5 - On-State Power Loss Characteristics

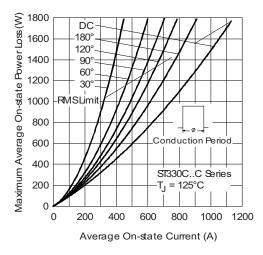


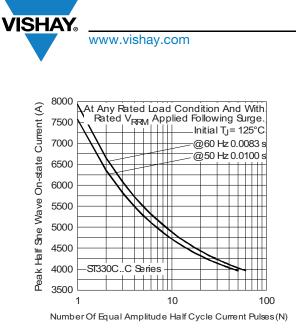
Fig. 6 - On-State Power Loss Characteristics

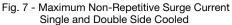
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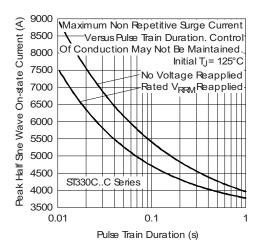
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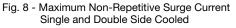
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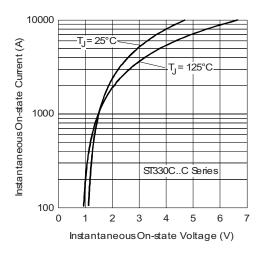
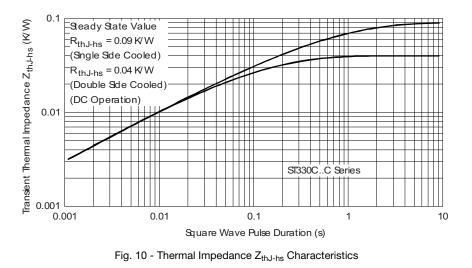
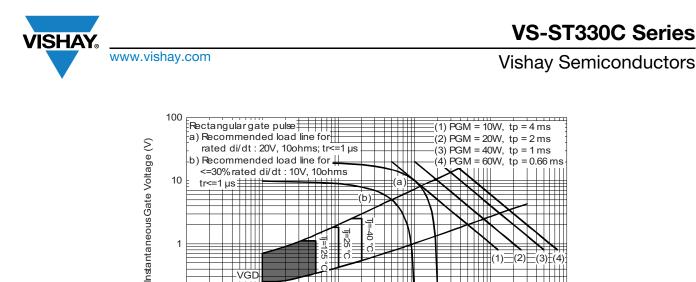


Fig. 9 - On-State Voltage Drop Characteristics





Device: ST330C..C Series

Fig. 11 - Gate Characteristics

0.1

Frequency Limited by PG(AV)

1

Instantaneous Gate Current (A)

10

100

0.01

0.1

**ORDERING INFORMATION TABLE** 

									1
Device code	VS-	ST	33	0	с	16	С	1	-
	1	2	3	4	5	6	7	8	9
	1.	· Visl	nay Sen	niconduc	ctors pro	oduct			
	2 -	- Thy	ristor						
	3 -	Ess	ential pa	art numt	ber				
	4 -	0 =	Conver	ter grade	е				
	5 -	- C =	Cerami	c PUK					
	6 -	Volt	age coo	le x 100	= V <sub>RRM</sub>	1 (see V	oltage F	Ratings	table)
	7.	- C =	PUK ca	ise TO-2	200AB (	E-PUK)			
	8 -	0 =	Eyelet t	erminals	s (gate a	and aux	iliary ca	thode u	nsolder
		1 =	Fast-on	termina	ls (gate	and au	xiliary c	athode	unsolde
		2 =	Eyelet t	erminals	s (gate a	and aux	iliary ca	thode s	oldered
		3 =	Fast-on	termina	ls (gate	and au	xiliary c	athode	soldere
	9	- Crit	ical dV/	dt: • No	ne = 50	0 V/µs (	standar	rd selec	tion)
				• L =	: 1000 V	∕/µs (spe	ecial se	lection)	

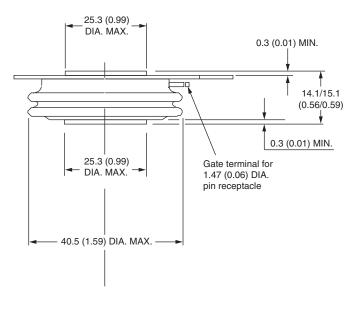
LINKS TO RELATED DOCUMENTS							
Dimensions http://www.vishay.com/doc?95075							
	·						

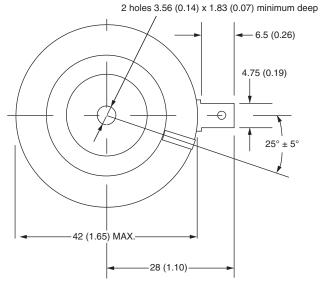


## TO-200AB (E-PUK)

#### **DIMENSIONS** in millimeters (inches)

Anode to gate Creepage distance: 11.18 (0.44) minimum Strike distance: 7.62 (0.30) minimum





Quote between upper and lower pole pieces has to be considered after application of mounting force (see thermal and mechanical specification)



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